
Contents

1	Introduction	1
1.1	Silver Metallization	1
1.2	Properties of Silver, Copper and Aluminum	5
1.3	References	6
2	Silver Thin Film Analysis	7
2.1	Introduction	7
2.2	Rutherford Backscattering Spectrometry	8
2.2.1	Scattering Kinematics	8
2.2.2	Scattering Cross Section	9
2.2.3	Depth Scale	10
2.2.4	Ion Resonances	11
2.3	X-ray Diffractometry	12
2.4	References	13
3	Diffusion Barriers and Self-encapsulation	15
3.1	Introduction	15
3.2	Titanium-nitride Self-encapsulation of Silver Films	16
3.2.1	Introduction	16
3.2.2	Experimental Details	17
3.2.3	Results	17
3.2.4	Discussion	20
3.2.5	Conclusions	22
3.3	Corrosion of Encapsulated Silver Films Exposed to a Hydrogen-sulfide Ambient	22
3.3.1	Introduction	22
3.3.2	Experimental Details	23
3.3.3	Results	24
3.3.4	Discussion	28
3.3.5	Conclusions	29

3.4 Tantalum–Nitride Films as Diffusion Barriers	30
3.4.1 Introduction	30
3.4.2 Experimental Details	30
3.4.3 Results	31
3.4.4 Discussion	39
3.4.5 Conclusions	41
3.5 References	42
4 Thermal Stability	43
4.1 Introduction	43
4.2 Silver-Aluminum Films	44
4.2.1 Introduction	44
4.2.2 Results	44
4.2.3 Discussion and Conclusions	46
4.3 Silver Deposited on Parylene- <i>n</i> by Oxygen Plasma Treatment	48
4.3.1 Introduction	48
4.3.2 Experimental Details	49
4.3.3 Results	50
4.3.4 Discussion	55
4.3.5 Conclusions	57
4.4 Effects of Different Annealing Ambients on Silver-Aluminum Bilayers	57
4.4.1 Introduction	57
4.4.2 Experimental Details	58
4.4.3 Results	59
4.4.4 Discussion	67
4.4.5 Conclusions	69
4.5 Thickness Dependence on the Thermal Stability of Silver Thin Films	69
4.5.1 Introduction	69
4.5.2 Experimental Details	70
4.5.3 Results and Discussion	70
4.5.4 Conclusions	73
4.6 References	74
5 Silver Electromigration Resistance	75
5.1 Introduction	75
5.2 Experimental Details	76
5.3 Results and Discussion	76
5.4 Conclusions	81
5.3 References	81
6 Integration Issues	83
6.1 Factors Influencing the Kinetics in Silver-Aluminum Bilayer Systems...	83
6.1.1 Introduction	83
6.1.2 Experimental Details	84
6.1.3 Results	84

6.1.4	Discussion	93
6.1.5	Conclusions	97
6.2	Effect of Metals and Oxidizing Ambient on Interfacial Reactions	97
6.2.1	Introduction	97
6.2.2	Experimental Details	98
6.2.3	Results	98
6.2.4	Discussion	101
6.2.5	Conclusions	103
6.3	Silver Metallization on Silicides with Nitride Barriers	103
6.3.1	Introduction	103
6.3.2	Experimental Details	104
6.3.3	Results and Discussions	105
6.3.4	Conclusions	109
6.4	References	110
7	Summary	113
7.1	Introduction	113
7.2	Thermal Stability: Diffusion Barriers and Self-encapsulation	113
7.3	Electromigration Resistance	117
7.4	Future Trends	118
7.5	References	119
Index		121